

PRODUCT / PROCESS CHANGE NOTIFICATION

PCN Number : **10033**

Product Identification (Including Customer P/N):		
K1526AA/AAM/AD/ADM		
Detailed Description of Changes: Converting to the K1526DA/DAM/DD/DDM.		
Reason for Changes: Improved quality, reliability, and shorter manufacturing cycle time. The K1526D mounts the components directly in the ceramic carrier, eliminating a drop-in substrate. This eliminates a level of interconnects, and a two step epoxy attachment process. The same components are used.		
Projected Timing of Change and Implementation Date:		
1-Dec-03		
Anticipated Impact on Quality and Reliability:		
Increased reliability is predicted due to a reduction in interconnects, and the elimination of the two step epoxy attachment process.		
Qualification Plan (if applicable): This product has been shipping for more than 2 years.		
Last Time Buy Date:	N/A	
Last Time Delivery Date and Comments (if applicable):		
M-tron Engineering:	<u>Joe Doyle</u>	Date: <u>10/13/2003</u>
M-tron Sales:	<u>Bill Jennewein</u>	Date: <u>10/13/2003</u>
M-tron Quality Assurance:	<u>JKocak</u>	Date: <u>10/13/2003</u>
CUSTOMER ACKNOWLEDGMENT OF RECEIPT / APPROVAL: Please return this signed document to: M-tron Industries, Inc., 100 Douglas Ave., Yankton, SD, 57078 Attention: Bill Jennewein Sales Application Engineer (605) 665-9321 ext. 176 FAX No: (605) 665-1709		
ACKNOWLEDGMENT / APPROVAL:		
Signature:	Title:	Date:
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